





#### **Features**

- $R_{DS(ON)} \le 3\Omega@V_{GS} = 10V$
- $R_{DS(ON)} \le 3.2 \Omega @V_{GS} = 4.5 V$
- High Density Cell Design For Ultra Low On-Resistance
- Very Low Leakage Current In Off Condition
- ESD Protected 2KV HBM
- AEC-Q101 qualified

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>
60 V	3.0 Ω	320.00 mA

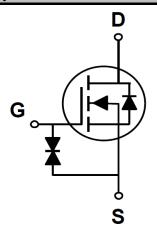
#### **Ordering Information**

J				
Part Name	Description			
FX2N7002KMEH-06S3	RoHs			
FX2N7002KMEH-06S3G	RoHs, Halogen Free			
FX2N7002KMEH-06S3Q	AEC-Q101 qualified			

#### Package type: SOT-23



#### **Graphic Symbol**





60V N-Channel MOSFET

Pb RoHS

#### **Absolute Maximum Ratings**

T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Rating	Unit
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub>	Drain Current - Continuous	320	mA
I <sub>DM</sub>	Pulsed Drain Current (Note 1)	2000	mA
$P_{D}$	Total Power Dissipation (Note 3)	350	mW
$T_J$	Operating JunctionTemperature Range	-55 to 150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C

	Thermal Resistance Ratings						
	Symbol	Parameter	Max	Unit			
Ī	$R_{ hetaJA}$	Thermal Resistance Junction to Ambient	357	°C/W			

#### **Electrical Characteristics**

(T<sub>J</sub>=25°C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Мах.	Units
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 10 \mu A$	60			V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±10	uA
$V_{GS (th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1.0		2.1	V
		$V_{GS}$ =5V, $I_D$ =50mA			2.8	
R <sub>DS (on)</sub>	Drain-Source On-Resistance	$V_{GS}$ =4.5V, $I_{D}$ =200mA			3.2	Ω
		$V_{GS}$ =10V, $I_D$ =500mA			3.0	
9 <sub>fs</sub>	Forward Transconductance	$V_{DS}$ =10V, $I_{D}$ =250mA		300		mS

Charges, Ca	Charges, Capacitance & Gate Resistance							
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units		
$Q_g$	Total Gate Charge	$V_{DS} = 15V$ , $V_{GS} = 5V$ , $I_{D} = 200$ mA			0.8	nC		
$C_{ISS}$	Input Capacitance				35			
Coss	Output Capacitance	$V_{DS}$ =25V, $V_{GS}$ =0V, F =1MHz			12	pF		
$C_{RSS}$	Reverse Transfer Capacitance				7			

Switching C	Characteristics					
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{DS} = 30V$ , $V_{GEN} = 10V$ , $R_{G} = 10\Omega$ ,		6		ne
$t_{d(off)}$	Turn-Off Delay Time	$I_{D} = 200 \text{mA}, R_{L} = 150 \Omega$		13		ns



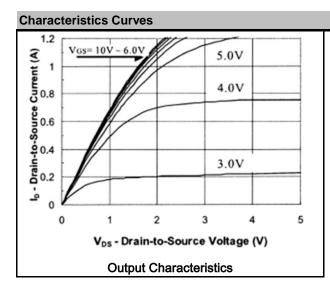


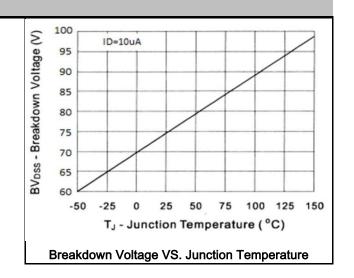
Drain-Source	Orain-Source Diode Characteristics and Ratings							
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units		
I <sub>S</sub>	Continuous Source Current				300	mA		
$V_{SD}$	Diode Forward Voltage	$V_{GS}$ =0V , $I_S$ =200mA		0.82	1.1	V		
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS}$ =0V, $V_{DD}$ =30V, $I_{S}$ =1A,		16.42		nS		
$Q_{rr}$	Reverse Recovery Charge	dls/dt=100A/us		9.02		nC		

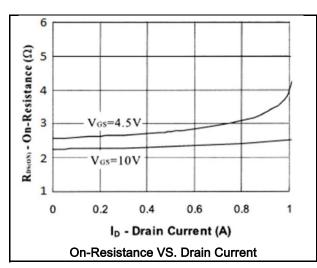
#### Notes

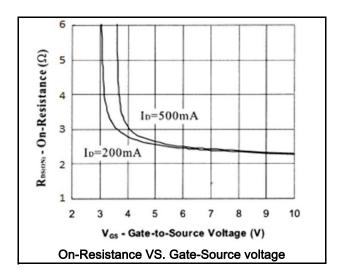
- 1.Maximum DC current limited by the package
- 2.Pulse test: pulse width≦ 300us, duty cycle≦ 2.0%.
- 3.1\*MRP FR-4 PC board,2oz.

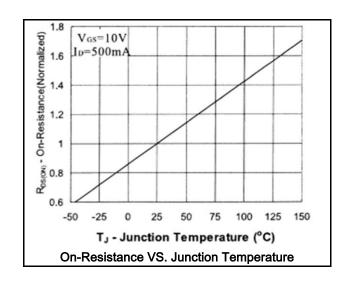


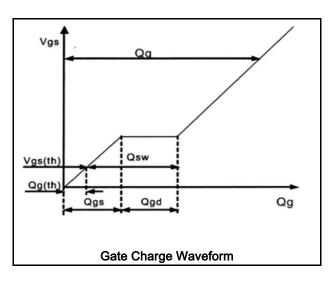




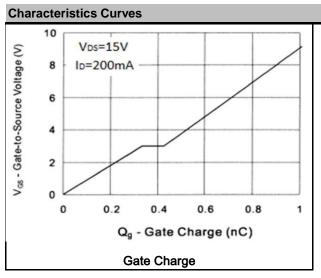


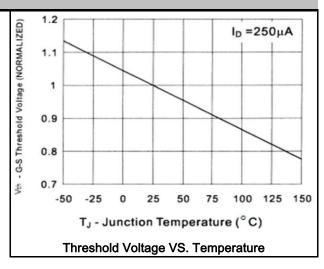


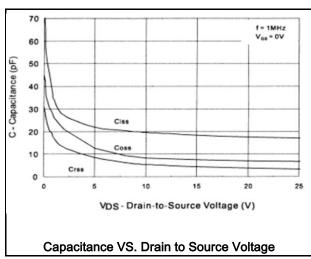


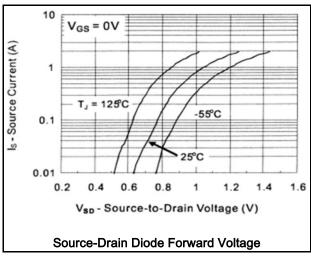


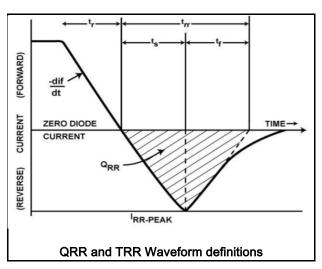


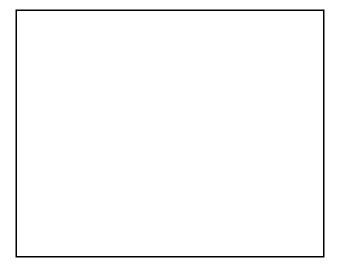






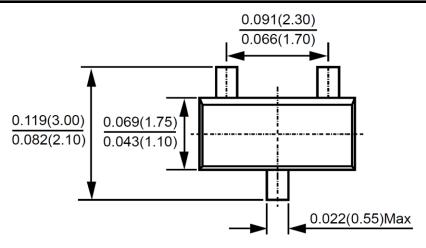


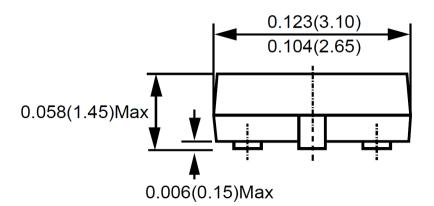


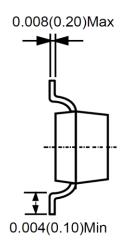




#### **Package Outline Dimensions**







TO-263
Dimensions in inches and (millimeters)



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